Industrial communication networks - Fieldbus specifications -- Part 2: Physical layer specification and service definition



EESTI STANDARDI EESSÕNA

NATIONAL FOREWORD

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EUROPEAN STANDARD NORME EUROPÉENNE EUROPÄISCHE NORM

EN 61158-2

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English version

Industrial communication networks -Fieldbus specifications -: Physical layer specification and service definition (IEC 61158-2:2010) Réseaux de communication industriels -Industrielle Kommunikationsnetze -Spécifications des bus de perrain -Feldbusse -Partie 2: Spécification des couches Teil 2: Spezifikation physiques et définition des services und Dienstfestlegungen des Physical (CEI 61158-2:2010) Layer (Bitübertragungsschicht) (IEC 61158-2:2010) This European Standard was approved by CENELEC on 2010-09-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the Central Secretariat or to any CENELEO nber. This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENERC member into its own language and notified to the Central Secretariat has the same status as the official versions CENELEC members are the national electrotechnical committees of Austria, Belgium, Bulgaria, Croatia, Cyprus, the Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Iceland, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, the Netherlands, Norway, Poland, Romania, Romania, Slovakia, Slovenia, Spain, Sweden, Switzerland and the United Kingdom. CENELFC European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung Management Centre: Avenue Marnix 17, B - 1000 Brussels

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Foreword

The text of document 65C/598/FDIS, future edition 5 of IEC 61158-2, prepared by SC 65C, Industrial networks, of IEC TC 65, Industrial-process measurement, control and automation, was submitted to the IEC-CENELEC parallel vote and was approved by CENELEC as EN 61158-2 on 2010-09-01.

This European Standard supersedes EN 61158-2:2008.

This EN 61158-2:2010 includes the following significant technical changes with respect to EN 61158-2:2008:

- for Type 18, Table 157 reduced tolerance to 5 %;
- for Type 18, in 32,5.3.1 removed minimum cable length;
- for Type 18, in 32.5 and R.2.2 cable reference removed;
- for Type 18, Table 169 and 161 terminating resistor value changed to 680 Ω .

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CEN and CENEEC shall not be held responsible for identifying any or all such patent rights.

The following dates were fixed:

- latest date by which the EN has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2011-06-01
 latest date by which the national standards conjucting
- with the EN have to be withdrawn

Annex ZA has been added by CENELEC.

Endorsement notice

2013-09-01

(dow)

The text of the International Standard IEC 61158-2:2010 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60079-0	NOTE	Harmonized as EN 60079-0.
IEC 60079-27	NOTE	Harmonized as EN 60079-27.
IEC 60875-1	NOTE	Harmonized as EN 60875-1.
IEC 60947-5-2	NOTE	Harmonized as EN 60947-5-2.
IEC/TR 61158-1	NOTE	Harmonized as CLC/TR 61158-1.
IEC 61158-4-1:2007	NOTE	Harmonized as EN 61158-4-1:2008 (not modified).
IEC 61158-4-4:2007	NOTE	Harmonized as EN 61158-4-4:2008 (not modified).
IEC 61158-4-7:2007	NOTE	Harmonized as EN 61158-4-7:2008 (not modified).
IEC 61158-4-8:2007	NOTE	Harmonized as EN 61158-4-8:2008 (not modified).
IEC 61158-4-16:2007	NOTE	Harmonized as EN 61158-4-16:2008 (not modified).
IEC 61300-3-4	NOTE	Harmonized as EN 61300-3-4.

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- IEC 61491 NOTE Harmonized as EN 61491.
- IEC 61596 NOTE Harmonized as EN 61596.
- IEC 61784-1 NOTE Harmonized as EN 61784-1.

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Annex ZA

(normative)

Normative references to international publications with their corresponding European publications

The following referenced documents are indispensable for the application of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

	O,			
Publication	Year	Title	<u>EN/HD</u>	<u>Year</u>
IEC 60050-731	-	International Electrotechnical Vocabulary (IEV) -	-	-
		Chapter 731: Optical fibre communication		
IEC 60079-11	-	Explosive atmospheres - Part 11: Fouipment protection by intrinsic safety "i"	EN 60079-11	-
IEC 60079-14	2002	Electrical appratus for explosive gas atmospheres - Part 14: Electrical installations in hazardous areas (other than integs)	EN 60079-14 ¹⁾	2003
IEC 60079-25	-	Explosive atmospheres Part 25: Intrinsically sate	EN 60079-25	-
IEC 60169-17	1980	Radio-frequency connectors - Part 17: R.F. coaxial connectors with inner diameter of outer conductors from (0,256 in) with screw coupling - Characteristic impedance 50 ohms (type TNC)	-	-
IEC 60189-1	2007	Low-frequency cables and wires with PVC insulation and PVC sheath - Part 1: General test and measuring methods	-	-
IEC 60255-22-1 (mod)	1988	Electrical relays - Part 22: Electrical disturbance tests for measuring relays and protection equipment - Section 1: 1 MHz burst disturbance tests	SL A	-
IEC 60364-4-41 (mod)	-	Low-voltage electrical installations - Part 4-41: Protection for safety - Protection against electric shock	HD 60264-4-41	-
IEC 60364-5-54 (mod)	-	Electrical installations of buildings - Part 5-54: Selection and erection of electrical equipment - Earthing arrangements, protective conductors and protective bonding conductors	HD 60364-5-54	-
IEC 60529	-	Degrees of protection provided by enclosures (IP Code)	-	-

 $^{^{1)}\,\}text{EN}$ 60079-14 is superseded by EN 60079-14:2008, which is based on IEC 60079-14:2007.

Publication	Year	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60603-7-4	-	Connectors for electronic equipment - Part 7-4: Detail specification for 8-way, unshielded, free and fixed connectors, for data transmissions with frequencies up to 250 MHz	EN 60603-7-4	-
IEC 60760	-	Flat, quick-connect terminations	-	-
IEC 60793	Series	Optical fibres	-	-
IEC 60794-1-2	2003	Optical fibre cables - Part 1-2: Generic specification - Basic optical cable test procedures	EN 60794-1-2	2003
IEC 60807-3	5000	Rectangular connectors for frequencies below 3 MHz - Part 3: Detail specification for a range of connectors with trapezoidal shaped metal shells and round contacts - Removable crimp types with closed crimp barrels, rear insertion/rear extraction	-	-
IEC 60874-10-1	-	Connectors for optical fibres and cables - Par 00-1: Detail specification for fibre optic connector type BFOC/2,5 terminated to multimede fibre type A1	-	-
IEC 61000-4-2	-	Electromagnetic compatibility (EMC) - Part 4-2: Testing and measurement techniques - Electrostatic discharge immunity test	EN 61000-4-2	-
IEC 61000-4-3	-	Electromagnetic compatibility (EMC) - Part 4-3: Testing and measurement techniques - Radiated, radio-frequency, electromagnetic field in munity test	EN 61000-4-3	-
IEC 61000-4-4	-	Electromagnetic compatibility (EMC) - Part 4-4: Testing and measurement techniques - Electrical fast transpent/burst immunity test	EN 61000-4-4	-
IEC 61131-2	-	Programmable controllers - Part 2: Equipment requirements and tests	EN 61131-2	-
IEC 61156-1	2007	Multicore and symmetrical pair/quad capies for digital communications - Part 1: Generic specification	-	-
IEC 61158-4-2	-	Industrial communication networks - Fieldbus specifications - Part 4-2: Data-link layer protocol specification - Type 2 elements	EN 61158-4-2	-
IEC 61158-4-3	2010	Industrial communication networks - Fieldbus specifications - Part 4-3: Data-link layer protocol specification - Type 3 elements	- ~r	-
IEC 61169-8	2007	Radio-frequency connectors - Part 8: Sectional specification - RF coaxial connectors with inner diameter of outer conductor 6,5 mm (0,256 in) with bayonet lock - Characteristics impedance 50 ohms (type BNC)	EN 61169-8	2007
IEC 61754-2	-	Fibre optic connector interfaces - Part 2: Type BFOC/2,5 connector family	EN 61754-2	-

EVS-EN 61158-2:2010

Publication	<u>Year</u>	Title	<u>EN/HD</u>	Year
IEC 61754-13	-	Fibre optic connector interfaces - Part 13: Type FC-PC connector	EN 61754-13	-
IEC 61754-22	-	Fibre optic connector interfaces - Part 22: Type F-SMA connector family	EN 61754-22	-
ISO/IEC 7498	Series	Information technology - Open Systems Interconnection - Basic Reference Model: The Basic Model	-	-
ISO/IEC 8482	-	Information technology - Telecommunications and information exchange between systems - Twisted pair multipoint interconnections	-	-
ISO/IEC 8802-3	,00C	Information technology - Telecommunications and information exchange between systems - Local and metropolitan area networks - Specific requirements - Part 3: Carrier sense multiple access with collision detection (CSMA/CD) access method and physical layer specifications	-	-
ISO/IEC 9314-1	-	Information Processing Systems - Fibre distributed data interface (FDDI) - Part 1: Teken Ring physical layer protocol (PHY)	-	-
ISO/IEC 10731	-	Information technology - Open Systems Interconnection Basic reference model - Conventions for the definition of OSI services	-	-
ANSI TIA/EIA-232-F	-	Interface between data terminal equipment and data circuit - Terminating equipment employing serial binary data interchange	-	-
ANSI TIA/EIA-422-E	3 -	Electrical characteristics of balanced voltage digital interface circuits	-	-
ANSI TIA/EIA-485-A	\ -	Electrical Characteristics of Generators and Receivers for Use in Balanced Digital Multipoint Systems	-	-
ANSI TIA/EIA-644-A	ι -	Electrical Characteristics of Low Voltage Differential Signaling (LVDS) Interface Circuits	NI TI	-
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0 Introduction

0.1 General

This part of IEC 61158 is one of a series produced to facilitate the interconnection of automation system components. It is related to other standards in the set as defined by the "three-layer" fieldbus reference model described in IEC/TR 61158-1.

0.2 Physical layer overview

The primary aim of this standard is to provide a set of rules for communication expressed in terms of the procedures to be carried out by peer Ph-entities at the time of communication.

The physical layer receives data units from the data-link Layer, encodes them, if necessary by adding communications framing information, and transmits the resulting physical signals to the transmission medun at one node. Signals are then received at one or more other node(s), decoded, if necessary by removing the communications framing information, before the data units are passed to the data-link Layer of the receiving device.

0.3 **Document overview**

This standard comprises physical layer specifications corresponding to many of the different DL-Layer protocol Types specified in EC 61158-4-1 to IEC 61158-4-18.

NOTE 1 The protocol Type numbers used are onsistent throughout the IEC 61158 series.

NOTE 2 Specifications for Types 1, 2, 3, 4, 8, Total 18 are included. Type 7 uses Type 1 specifications. The other Types do not use any of the specifications given othis standard.

NOTE 3 For ease of reference, Type numbers are given belause names. This means that the specification given therein applies to this Type, but does not exclude its use for other Types.

NOTE 4 It is up to the user of this standard to select interviewating sets of provisions. Refer to the IEC 61784 series for standardized communication profiles based on the IEC 61158 series.

A general model of the physical layer is shown in Figure

The common characteristics for all variants and types are afollows:

- digital data transmission;
- no separate clock transmission;
- no separate clock transmission, either half-duplex communication (bi-directional but in only one direction at a time) or full-duplex communication.